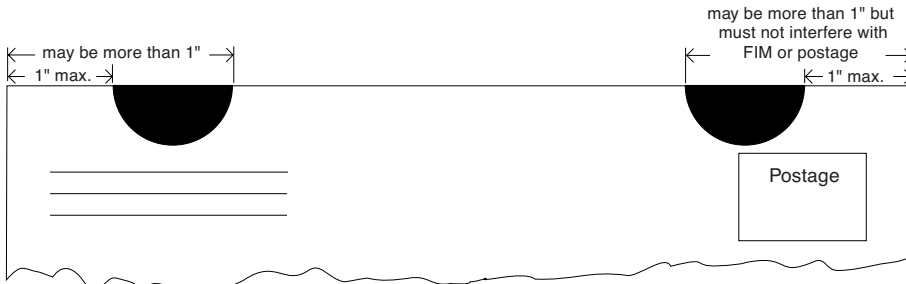


Placement of Tabs and Wafer Seals



Specifications for Automation-Compatible Letter-Size Mailpieces